

April 9, 2007

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

FROM:

Stephen B. Ackerman, Reg. No. 37,761

28 Davis Avenue

Poughkeepsie, N.Y. 12603

SUBJECT:

Serial #:

10/685,872

File Date:

10/15/03

Inventor:

M. S. Lin

Examiner:

Kevin M. Picardat

Art Unit:

2822

Title:

Post Passivation Interconnection Schemes On Top Of The

IC Chips

Customer Number: 28112

## COMMUNICATION REGARDING ISSUE FEE PAYMENT

This regards the Notice of Allowance dated January 10, 2007 for the above referenced subject patent application. The application had previously been allowed on July 11, 2006 and we paid the Issue Fee on September 18, 2006 at the small entity rate of \$700. Attached is a copy of the post card with the Issue Fee, Publication fee and request for 8 copies paid.

Applicant filed a petition under 37 CFR 1.313 (c) (2) on October 30, 2006, to withdraw the above-mentioned application from issue after payment of the issue fee. The petition was GRANTED.

## CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on April 19, 2007.

Signature

STEPHEN B. ACKDRMON, REG. NO. 37,761

Date:

MEG02-015CCC

The subject application was subsequently allowed again on January 10, 2007. The Applicant is no longer claiming small entity status. Please see box 5b on the Part B –Fee Transmittal.

Please accept this payment of the Issue Fee.

Respectfully submitted,

Stephen B. Ackerman Reg. #37,761

**Enclosures** 

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